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| 1. Record Nr. | UNISA996217252403316 |
| Titolo | RTP 2001 : 9th International Conference on Advanced Thermal Processing of Semiconductors : September 25-29, 2001, Hilton Anchorage, Alaska // D.P. DeWitt ... [et al.], editors |
| Pubbl/distr/stampa | IEEE |
| Altri autori (Persone) | DeWittDavid P. <1934-> |
| Soggetti | Semiconductors - Heat treatment
Rapid thermal processing
Semiconductor doping
Semiconductors - Defects |
| Lingua di pubblicazione | Inglese |
| Formato | Materiale a stampa |
| Livello bibliografico | Monografia |
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| 2. Record Nr. | UNINA9910701781903321 |
| Autore | Liu Kuang C |
| Titolo | Impact of material and architecture model parameters on the failure of woven Ceramic Matrix Composites (CMCs) via the multiscale generalized method of cells [[electronic resource] /] / Kuang C. Liu, Steven M. Arnold ; prepared for the 35th International Conference and Exposition on Advanced Ceramics and Composites (ICACC '11) sponsored by the American Ceramic Society, Daytona Beach, Florida, January 23-28, 2011 |
| Pubbl/distr/stampa | Cleveland, Ohio : , : National Aeronautics and Space Administration, Glenn Research Center, , [2011] |
| Descrizione fisica | 1 online resource (21 pages) : color illustrations |
| Collana | [NASA technical memorandum] ; ; NASA/TM-2011-217011 |
| Altri autori (Persone) | ArnoldS. M |
| Soggetti | Ceramic matrix composites
Microstructure
Matrix materials
Stress-strain relationships |
| Lingua di pubblicazione | Inglese |

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Livello bibliografico	Monografia
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